

SPICE thermal model

GaN041-650WSB

`		Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base		-	-	0.80	K/W
	Cth ₁	0.31792900 F		↑ t _j		
	Cth ₂	0.00106364 F			_	
	Cth ₃	0.00009545 F		Дъ.,	<u></u>	
	Cth ₄	0.00340863 F		Rth ₁		
	Cth ₅	0.01166980 F				
	Cth ₆	0.00917218 F		- -	7	
				Rth ₂		
				닌.		
					٦	
	Rth ₁	0.12325600 Ω		Rth ₃	±Cth3	
	Rth ₂	0.02413000 Ω		닌_		
	Rth ₃	0.01047630 Ω			_	
	Rth ₄	0.04437110 Ω		□Rth₄	Cth₄	
	Rth ₅	0.06283700 Ω		Ų' 4	Tour	
	Rth ₆	0.53194300 Ω	(P)		_	
			\vee	ή	\perp	
				∐Rtn ₅		
					7	
				Rth6		
				닌.		
Part:	GaN041-650WSB					
				t _{amb}		
Date:	25/3/2021			V 4		
Model Rth	0.80 K/V	V				